

## 100302 Low Power Quint 2-Input OR/NOR Gate

Check for Samples: [100302](#)

### FEATURES

- 43% power reduction of the 100102
- 2000V ESD protection
- Pin/function compatible with 100102
- Voltage compensated operating range =  $-4.2\text{V}$  to  $-5.7\text{V}$
- Standard Microcircuit Drawing
  - (SMD) 5962-9152802

### DESCRIPTION

The 100302 is a monolithic quint 2-input OR/NOR gate with common enable. All inputs have 50 k $\Omega$  pull-down resistors and all outputs are buffered.

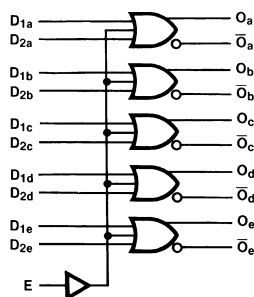


Table 1. Pin Descriptions

Pin Names	Description
$D_{na}$ – $D_{ne}$	Data Inputs
E	Enable Input
$O_a$ – $O_e$	Data Outputs
$\overline{O}_a$ – $\overline{O}_e$	Complementary Data Outputs

### Truth Table

(1)

$D_{1X}$	$D_{2X}$	E	$O_X$	$\overline{O}_X$
L	L	L	L	H
L	L	H	H	L
L	H	L	H	L
L	H	H	H	L
H	L	L	H	L
H	L	H	H	L
H	H	L	H	L
H	H	H	H	L

(1) H = HIGH Voltage Level  
L = LOW Voltage Level

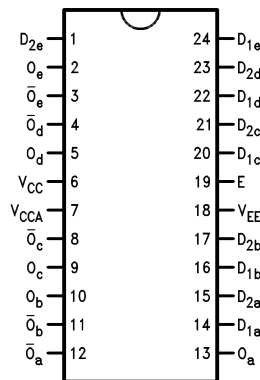


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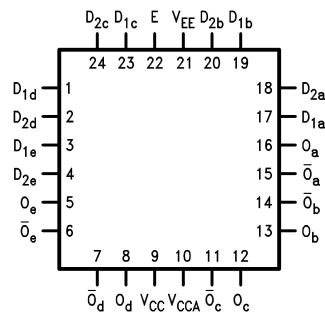
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## Connection Diagram

**Figure 1. 24-Pin DIP**



**Figure 2. 24-Pin Quad Cerpak**



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### Absolute Maximum Ratings <sup>(1)</sup>

Above which the useful life may be impaired	
Storage Temperature ( $T_{STG}$ )	-65°C to +150°C
Maximum Junction Temperature ( $T_J$ )	
Ceramic	+175°C
$V_{EE}$ Pin Potential to Ground Pin	-7.0V to +0.5V
Input Voltage (DC)	$V_{EE}$ to +0.5V
Output Current (DC Output HIGH)	-50 mA
ESD <sup>(2)</sup>	≥2000V

- (1) Absolute maximum ratings are those values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.  
 (2) ESD testing conforms to MIL-STD-883, Method 3015.

### Recommended Operating Conditions

Case Temperature ( $T_C$ )	
Military	-55°C to +125°C
Supply Voltage ( $V_{EE}$ )	-5.7V to -4.2V

**Military Version  
DC Electrical Characteristics**
 $V_{EE} = -4.2V$  to  $-5.7V$ ,  $V_{CC} = V_{CCA} = GND$ ,  $T_C = -55^{\circ}C$  to  $+125^{\circ}C$  <sup>(1)</sup>

Symbol	Parameter	Min	Max	Units	T <sub>C</sub>	Conditions	Notes	
V <sub>OH</sub>	Output HIGH Voltage	-1025	-870	mV	0°C to +125°C	V <sub>IN</sub> = V <sub>IH(Max)</sub> or V <sub>IL (Min)</sub>	Loading with 50Ω to -2.0V	(2)(3)(1)
		-1085	-870	mV	-55°C			
V <sub>OL</sub>	Output LOW Voltage	-1830	-1620	mV	0°C to +125°C			
		-1830	-1555	mV	-55°C			
V <sub>OHC</sub>	Output HIGH Voltage	-1035		mV	0°C to +125°C	V <sub>IN</sub> = V <sub>IH(Max)</sub> or V <sub>IL (Min)</sub>	Loading with 50Ω to -2.0V	(2) (3) (1)
		-1085		mV	-55°C			
V <sub>OLC</sub>	Output LOW Voltage		-1610	mV	0°C to +125°C			
			-1555	mV	-55°C			
V <sub>IH</sub>	Input HIGH Voltage	-1165	-870	mV	-55°C to +125°C	Guaranteed HIGH Signal for All Inputs	(2) (3) (1) (4)	
V <sub>IL</sub>	Input LOW Voltage	-1830	-1475	mV	-55°C to +125°C	Guaranteed LOW Signal for All Inputs	(2) (3) (1) (4)	
I <sub>IL</sub>	Input LOW Current	0.50		μA	-55°C to +125°C	V <sub>EE</sub> = -4.2V V <sub>IN</sub> = V <sub>IH (Max)</sub>	(2) (3) (1)	
I <sub>IH</sub>	Input HIGH Current		240	μA	0°C to +125°C	V <sub>EE</sub> = -5.7V V <sub>IN</sub> = V <sub>IL (Min)</sub>	(2) (3) (1)	
			340	μA	-55°C			
I <sub>EE</sub>	Power Supply Current	-48	-17	mA	-55°C to +125°C	Inputs Open	(2) (3) (1) (4)	

- (1) Sample tested (Method 5005, Table I) on each manufactured lot at -55°C, +25°C, and +125°C, Subgroups A1, 2, 3, 7, and 8.
- (2) F100K 300 Series cold temperature testing is performed by temperature soaking (to guarantee junction temperature equals -55°C), then testing immediately without allowing for the junction temperature to stabilize due to heat dissipation after power-up. This provides "cold start" specs which can be considered a worst case condition at cold temperatures.
- (3) Screen tested 100% on each device at -55°C, +25°C, and +125°C, Subgroups 1, 2, 3, 7, and 8.
- (4) Guaranteed by applying specified input condition and testing V<sub>OH</sub>/V<sub>OL</sub>.

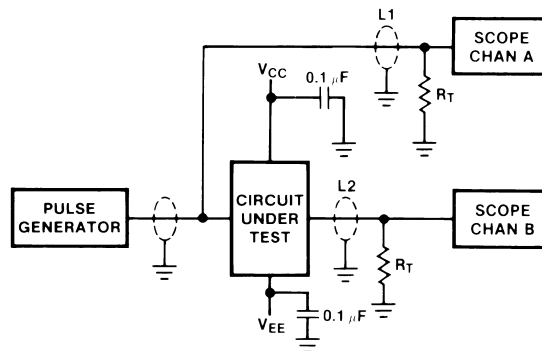
## AC Electrical Characteristics

 $V_{EE} = -4.2V$  to  $-5.7V$ ,  $V_{CC} = V_{CCA} = GND$ 

Symbol	Parameter	$T_C = -55^\circ C$		$T_C = +25^\circ C$		$T_C = +125^\circ C$		Units	Conditions	Notes
		Min	Max	Min	Max	Min	Max			
$t_{PLH}$ , $t_{PHL}$	Propagation Delay Data to Output	0.30	1.80	0.40	1.50	0.40	1.70	ns	Figure 3 Figure 4	*(1) (2) (3) (4) (5)
$t_{PLH}$ , $t_{PHL}$	Propagation Delay Enable to Output	0.60	2.60	0.80	2.30	0.80	2.80	ns		
$t_{TLH}$ , $t_{THL}$	Transition Time 20% to 80%, 80% to 20%	0.30	1.20	0.30	1.20	0.30	1.20	ns		(4)

- (1) F100K 300 Series cold temperature testing is performed by temperature soaking (to guarantee junction temperature equals  $-55^\circ C$ ), then testing immediately after power-up. This provides "cold start" specs which can be considered a worst case condition at cold temperatures.
- (2) Screen tested 100% on each device at  $+25^\circ C$  temperature only, Subgroup A9.
- (3) Sample tested (Method 5005, Table I) on each manufactured lot at  $+25^\circ C$ , Subgroup A9, and at  $+125^\circ C$  and  $-55^\circ C$  temperatures, Subgroups A10 and A11.
- (4) Not tested at  $+25^\circ C$ ,  $+125^\circ C$ , and  $-55^\circ C$  temperature (design characterization data).
- (5) The propagation delay specified is for single output switching. Delays may vary up to 100 ps with multiple outputs switching.

## Test Circuitry



### Notes:

 $V_{CC}$ ,  $V_{CCA} = +2V$ ,  $V_{EE} = -2.5V$ 
 $L1$  and  $L2$  = equal length 50Ω impedance lines

 $R_T = 50\Omega$  terminator internal to scope

 Decoupling 0.1  $\mu F$  from GND to  $V_{CC}$  and  $V_{EE}$ 

All unused outputs are loaded with 50Ω to GND

 $C_L$  = Fixture and stray capacitance  $\leq 3$  pF

**Figure 3. AC Test Circuit**

## Switching Waveforms

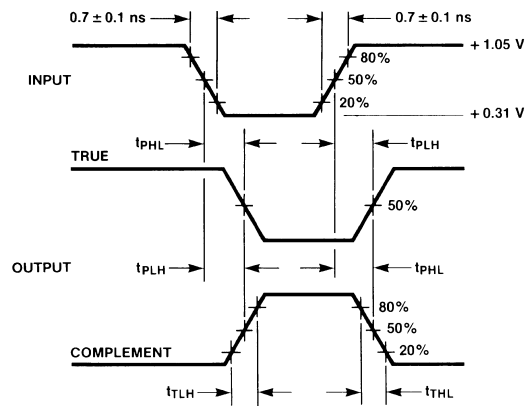


Figure 4. Propagation Delay and Transition Times

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